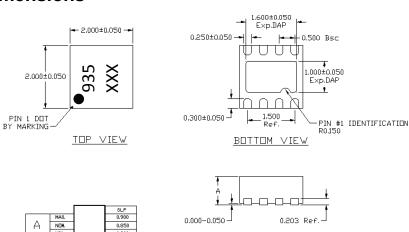
Mechanical Information

Package Information and Dimensions

This package is lead-free/RoHScompliant. The plating material on the backside and leads is annealed matte tin.

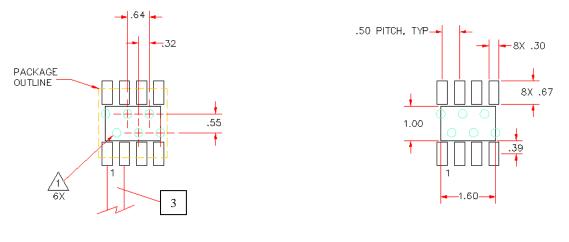
The component will be marked with a "935" designator with an alphanumeric lot code on the top surface of package. The "XXX" is an auto generated number.



<u>side view</u>

PCB Mounting Pattern

All dimensions are in millimeters (inches). Angles are in degrees.



COMPONENT SIDE

Notes:

- 1. Ground / thermal vias are critical for the proper performance of this device. Vias should use a .35mm (#80 / .0135") diameter drill and have a final plated thru diameter of .25 mm (.010").
- 2. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
- 3. RF trace width depends upon the PC board material and construction.

4. Use 1 oz. Copper minimum.

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